

Product Overview

HX6610SA complete single-cell lithium-ion battery charger with reverse polarity protection and constant current/constant voltage linear control

The low number of external components makes HX6610S ideal for portable applications. HX6610S can be suitable for USB power supply and adapter

The adapter power supply is working.

Due to the internal PMOSFET architecture, coupled with the anti-reverse charging circuit, does not require an external detection resistor and isolation diode.

The charge current can be automatically adjusted to limit the chip temperature under high power operation or high ambient temperature conditions.

When the battery reaches V_{float} (Typical 4.22V) after which the charging current drops to the set value $1/10$, HX6610S

Charging will terminate automatically.

When the input voltage (AC adapter or USB) when the power supply is removed, HX6610S automatically enters a low current state, battery drain current

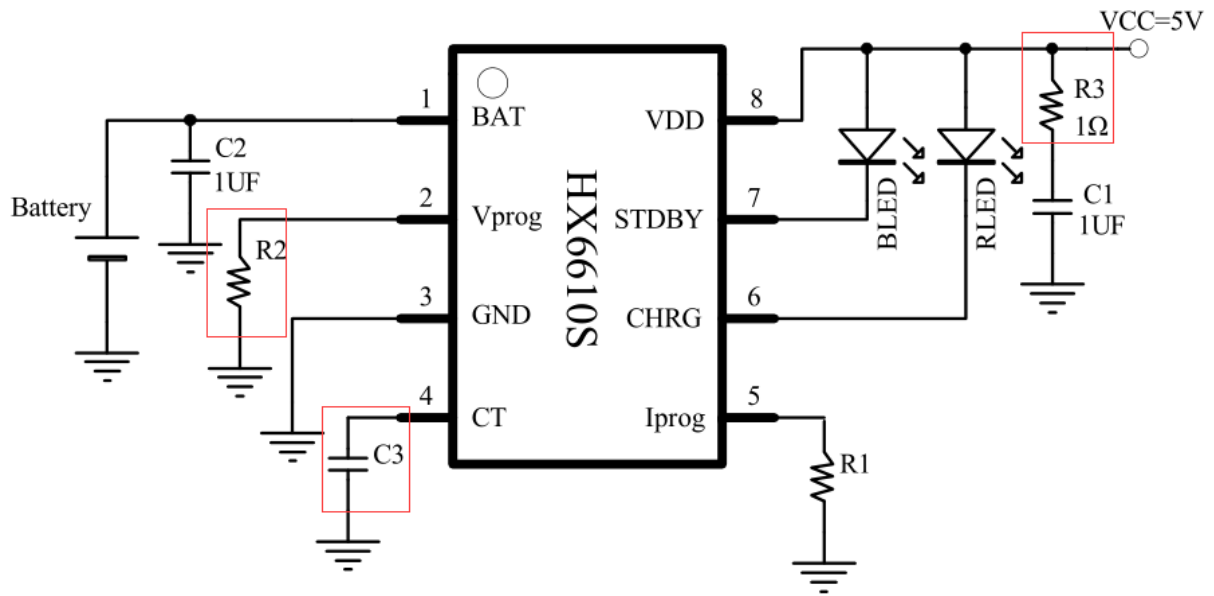
3uA the following. HX6610S other features include charge current monitor, undervoltage lockout, automatic recharge and two end-of-charge and output

The status pin to which the input voltage is connected.

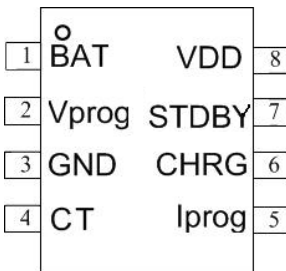
Main Features

- Presets 4.22V $\pm 1\%$ charging voltage;
- The charging voltage is externally adjustable and can be as high as the input voltage;
- Trickle/constant current/constant voltage three-stage charging, charging current externally adjustable, maximum charging current can reach 1A;
- Maximum input voltage: 7V;
- Support 0V battery charging;
- Standby current is less than 1uA;
- Short circuit protection function;
- OVP protection function, input higher than 6.2V, stop charging
- BAT-VDD voltage backflow prevention function;
- Battery reverse polarity protection to prevent the chip from being burned due to reverse polarity of the battery;
- Intelligent temperature control technology, the charging current will decrease as the temperature rises, and the maximum charging current will be output without overheating protection;
- Soft start limits inrush current;
- Directly from USB the port charges a single-cell lithium-ion battery;
- Automatic recharging;
- support 1 light mode and two-light mode;
- Highly integrated, with very few peripheral components;
- ESOP-8 (HX6610S) and DIP-8 (HX6610D) packages

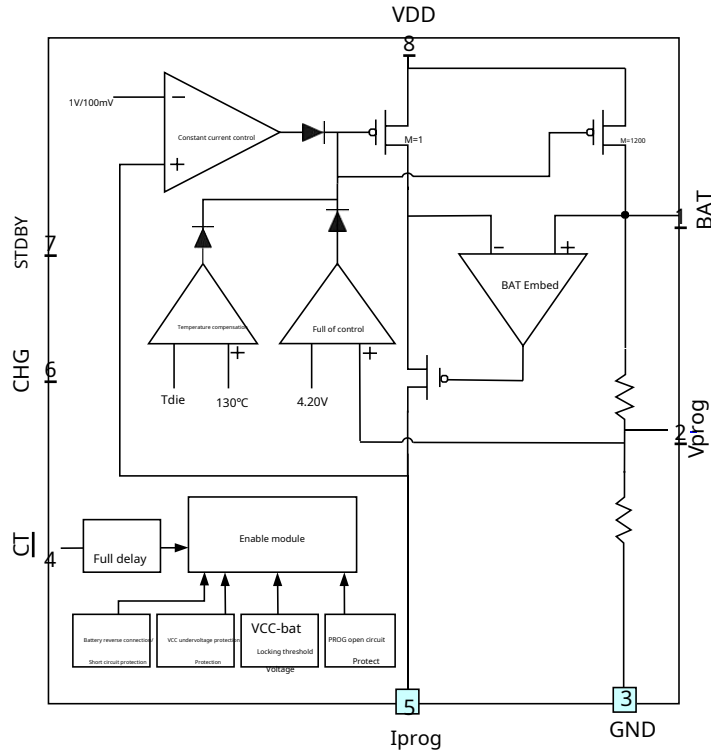
Schematic



Pin Definition

	Pin Name	Pinout	Functional Description
	BAT	1	Battery positive terminal
	Vprog	2	No-load voltage adjustment pin:1,R2When not answering,Vfloat =4.22V 2, by settingR2Resistance value, set the floating charge threshold voltage according to usage requirements
	GND	3	Negative pole of power supply (ground)
	CT	4	Full time delay setting (not required if delay is not needed)
	Iprog	5	Charge current adjustment pin
	CHG	6	Charging indicator pin
	STDBY	7	Saturation indicator pin
	VDD	8	Positive power supply

Circuit internal structure diagram



Electrical characteristics parameters

(Unless otherwise specified, all parameters are measured at room temperature and are GNDThe terminal potential is 0Potential

symbol	characteristic	Test conditions	unit	Min	Type	Max
VIN	Input voltage range		V	4.5		6
VINPower failure monitoring Test	VINLow to High	Vin>BAT	mV	-	100	-
	VINHigh to Low	Vin>BAT	mV	-	30	-
Vfloat	Float charge threshold voltage	VDD=5V,R2No	V	4.18	4.22	4.26
VOVP	Input overvoltage protection		V		6.2	
Ibat	BATBackflow current	Vcc=3.5V,Vbat=4.2V Vcc=0V,R2No	uA	-	±0.5	±5
VTRKL	Trickle flow to constant flow	VBATLow to High	V	-	2.8	-
VTRHYS	Trickle charge hysteresis voltage		mV	-	100	-
VUV	VccUndervoltage lockout threshold	VccLow to High	V	-	3.7	-
VUVHYS	VccUndervoltage Lockout Hysteresis		mV	-	200	-
Vmsd	Manual shutdown threshold voltage		V	-	1.2	-
VxDV	Manual shutdown hysteresis voltage		mV	-	50	-
Vprog1	TricklePROGVoltage		V	-	0.1	-
Vprog2	At high currentPROGVoltage		V	-	1	-
OTR	Over temperature recovery (constant temperature mode)	VDD=5V	°C	-	130	-

Application Information

Normal charging cycle

when V_{cc} The pin voltage rises to V_{LO} Above the threshold level and I_{PROG} precision 1% Setting of electric

A charging cycle begins when a resistor is connected or when a battery is connected to the charger output. BAT The pin level is lower than 2.8V, the charger enters

In this mode, HX6610S Provide about 1/10 Set the charging current to increase the current voltage to a safe level.

level, thus achieving full current charging. BAT The pin voltage rises to 2.8V When the current is above 200V, the charger enters the constant current mode, supplying

Provides a constant charging current. BAT pin voltage reaches the final float voltage (typical 4.22V) hour, HX6610S Entering constant voltage mode,

And the charging current starts to decrease. When the charging current drops to the set value 1/10, the charging cycle ends.

Charging current setting

The charging current is connected to $PROG$ The resistor between the pin and ground is used to set the charging current.

$$\frac{1200}{I_{bat}}$$

Calculate by formula: Determine the resistor value according to the required charging current, formula 1: $R = \frac{1200}{I_{bat}}$ Example 1: When the charging current needs to be set to I_{BAT}

$$\frac{1200}{0.2A}$$

= 6000 Ω Right now $R_{PROG} = 6k\Omega$ The maximum charging current can be set to 1A, but in greater than

0.5A In the application, the chip heat is relatively large, the temperature protection will reduce the charging current, and the test current in different environments will also be different from the theoretical value calculated by the formula.

Completely consistent. In customer applications, you can select the appropriate size according to your needs. R_{PROG} .

Full voltage setting

HX6610S The floating charge threshold voltage is adjusted by V_{prog} The resistor and the full voltage are set using the following formulas:

Formula: Determine the resistor value according to the required full charge. When the full charge voltage is set higher than 4.22V (Typical value) , V_{prog} Connect an electric

$$\frac{2.20 * 265000}{V_{prog} - 4.20}$$

Resistance R , using formula 1: $R = \frac{2.20 * 265000}{V_{prog} - 4.20}$ Example 1: When the full voltage needs to be set $V_{prog} = 4.5V$ When using formula 1

$$\frac{2.20 * 265000}{4.5 - 4.20}$$

have to: $R = \frac{2.20 * 265000}{4.5 - 4.20} = 1.940M\Omega$ When the full voltage is set below 4.2V, V_{prog} arrive BAT Connect a resistor R , using formula 2:

$$\frac{(V_{prog} - 2.2) * 291500}{2.2}$$

$R / 265000 = \frac{(V_{prog} - 2.2) * 291500}{2.2}$, Example 2, when the full voltage needs to be set to $V_{prog} = 3.6V$ When , use formula 2 to calculate:

$$R = 618K\Omega.$$

Shutdown delay setting

The full turn-off delay is adjusted by the capacitor and the turn-off delay are set using the following formula:

To calculate: Determine the capacitance value according to the required shutdown delay,

$$C = \frac{1.5 * 10^{-6}}{2.2} * T$$

Example 1: When you need to set the shutdown delay to 30ms, the formula is used to calculate: $C = \frac{1.5 * 10^{-6}}{2.2} * 30 * 10^{-3}$

=20.50nF

Battery reverse polarity protection function

With lithium battery reverse connection protection function, when the positive and negative poles of the lithium battery are reversely connected to HX6610S Vbat Output pins, HX6610S will stop display

Fault condition, two LEDs are off. At this time, the leakage current of the reverse-connected lithium battery is less than 0.5mA. Connect the reversed battery correctly. HX6610S

Restore normal charging state. In case of reverse connection of battery, the power supply voltage plus the battery voltage cannot exceed 8V.

Charging status indicator (CHRG STDBY)

There are two open-drain status indication outputs, CHG and STDBY. When the charger is in charging state, CHG will

Pull to low level, STDBY in high impedance state. When the battery is reversed or short-circuited, CHG and STDBY both are in high impedance state and both lights are off.

When the status indication function is not used, connect the unused status indication output terminal to GND.

VIN	BAT	CHG	STDBY
disconnect	Access	Destroy	Destroy
Access	disconnect	Destroy	Bright
Access	Charging	Bright	Destroy
Access	full	Destroy	Bright
Access	Short circuit/reverse connection	Destroy	Destroy

Thermal Limitation

If the chip temperature attempts to rise to approximately 130°C. If the temperature rises above a preset value, an internal thermal feedback loop will reduce the set charge current.

Prevents HX6610S from overheating and allows the user to push the upper limit of a given board's power handling capabilities without damage to HX6610S.

The charger can be set based on typical (rather than worst-case) ambient temperature, with the assurance that the charger will automatically reduce current under worst-case conditions.

Electric current.

Increased thermal regulation

reduces the pressure drop across the two ends can be significantly reduced. This has the effect of increasing the charging current during thermal regulation.

The input power supply can be V_{CC}. Connect one in series with 0.25 Ω power resistance or forward voltage drop is less than 0.5V. The diode transfers part of the power

Consume.

Undervoltage Lockout

An internal undervoltage lockout circuit monitors the input voltage and VDD. It keeps the charger in shutdown mode until it exceeds the undervoltage lockout threshold model. UVLO. The circuit will keep the charger in shutdown mode. UVLO. If the comparator jumps, VDD rising to a voltage higher than the battery voltage 50mV. The charger will not exit shutdown mode before then.

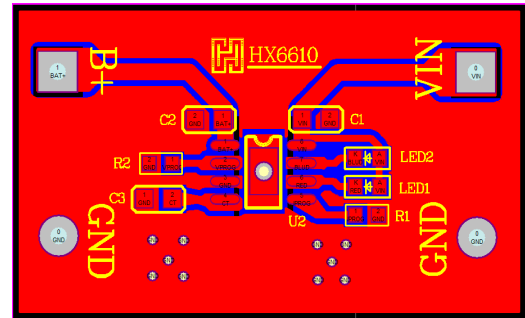
PCB Design Guidelines

In design HX6610S PCB, the following guidelines apply:

VDD: The bypass capacitor needs to be close to the chip VDD and GND pin.

Vbat: The bypass capacitor needs to be close to the chip Vbat and GND pin.

R2: Need to be close to the chip Vprog, in order to reduce Vfloat interference.



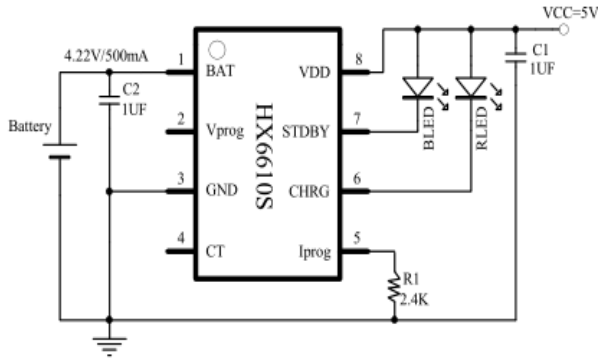
Static Electricity Protection Measures

MOSThe circuit is an electrostatically sensitive device. The following precautions should be taken during production and transportation to effectively prevent MOSThe circuit is

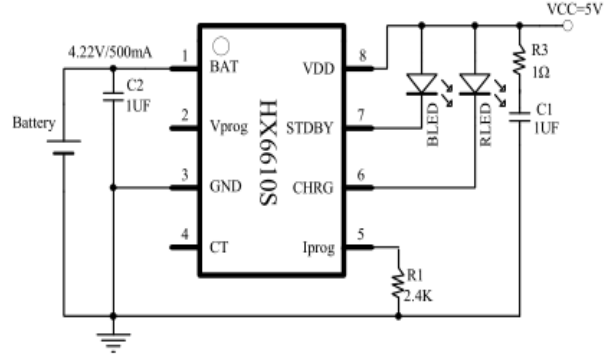
Damage caused by electrostatic discharge:

- Operators must be grounded using an anti-static wrist strap;
- The casing of production equipment must be grounded;
- Tools used during assembly must be grounded;
- Conductive packaging or antistatic materials must be used for packaging or transportation.

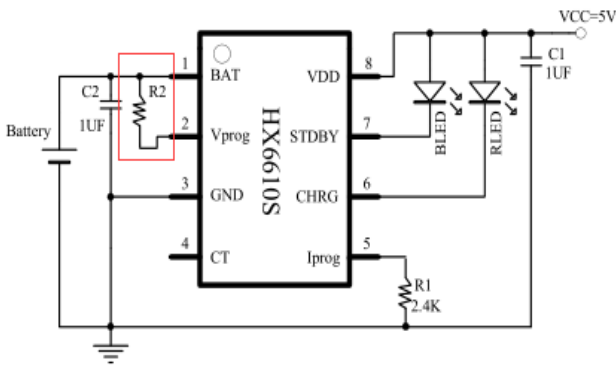
Typical application reference circuit



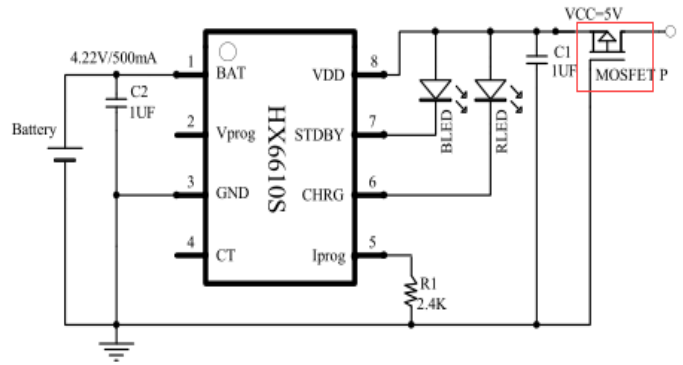
General use



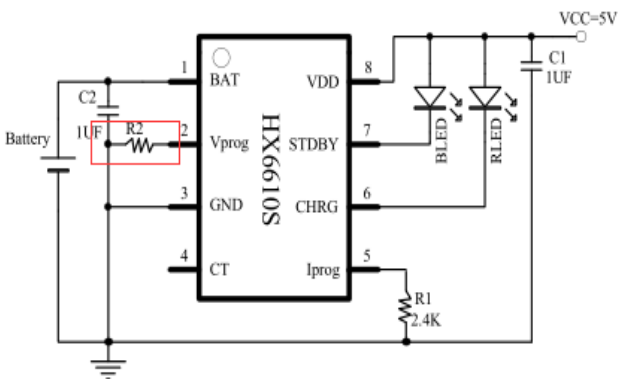
Reduce the instantaneous high voltage of the charger



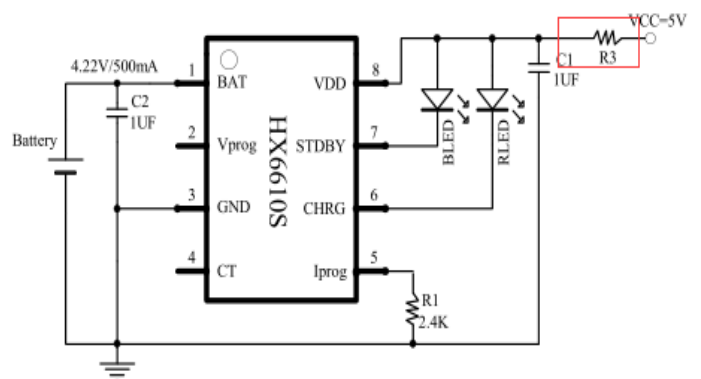
Full voltage is lower than 4.2V



With input reverse polarity protection

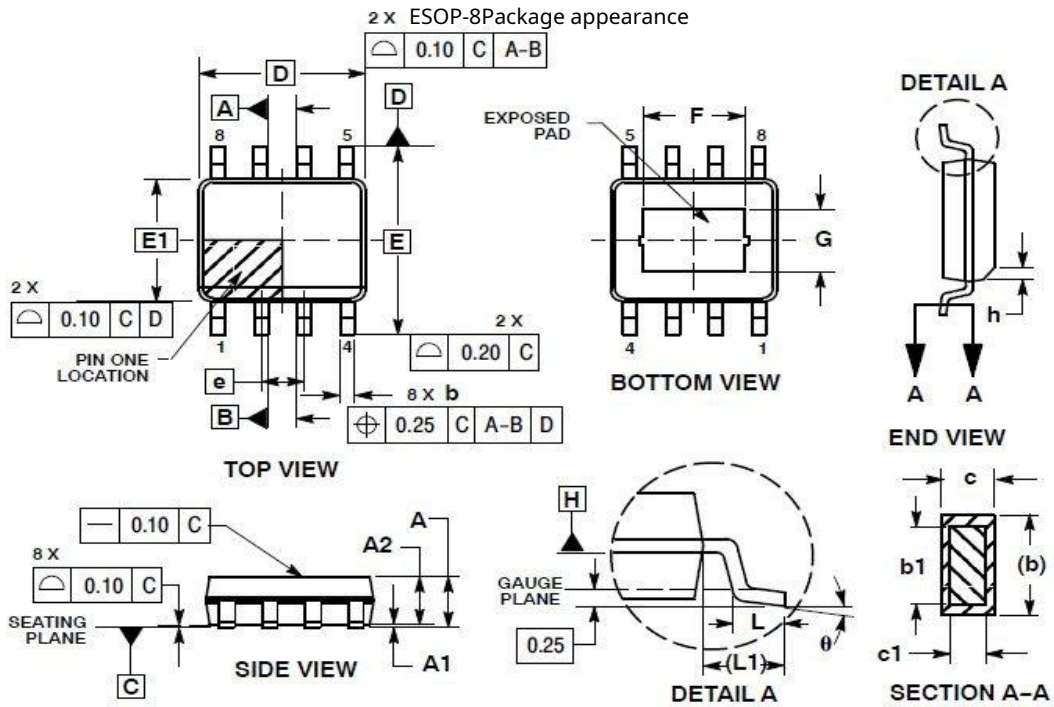


Full charge voltage is higher than 4.22V

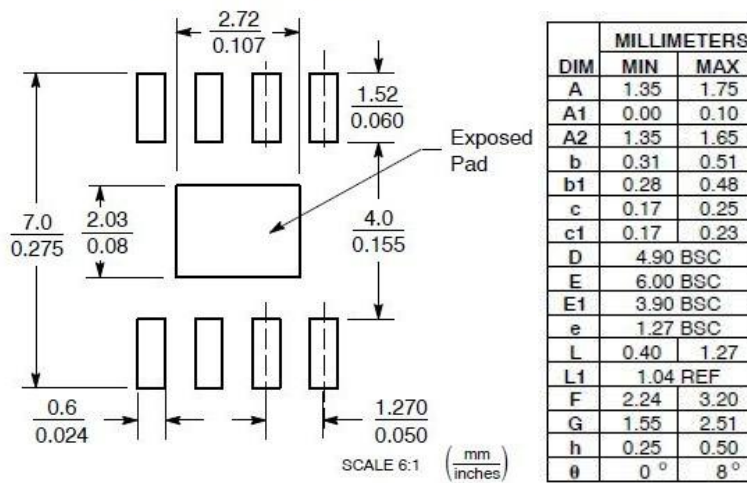


Full function connection dissipation resistor

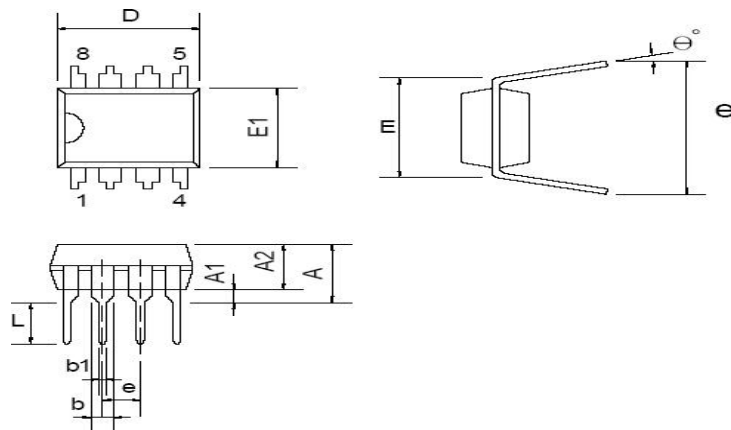
Packaging information



SOLDERING FOOTPRINT



DIP-8Package appearance



symbol	Millimeters			inch		
	Minimum	typical	maximum	Minimum	typical	maximum
A			5.334			0.210
A1	0.381			0.015		
A2	3.175	3.302	3.429	0.125	0.130	0.135
b		1.524			0.060	
b1		0.457			0.018	
D	9.017	9.271	10.160	0.355	0.365	0.400
E		7.620			0.300	
E1	6.223	6.350	6.477	0.245	0.250	0.255
e		2.540			0.100	
L	2.921	3.302	3.810	0.115	0.130	0.150
eB	8.509	9.017	9.525	0.335	0.355	0.375
θ	0	7	15°	0°	7	15°